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201726 201VZL430354 - Wiring, Printed - Component



ZPMV2.E490354  
Wiring, Printed - Component

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Wiring, Printed - Component

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E490354

	Cond Width			SS/ DS/	Area Diam	Solder		Temp		Flame	RoHS	C
	Min	Max	Min			Max	Class	DSR				
Typ	max(in)	mm(in)	mic(mil)	DSO	mm(in)	C	sec	C	Class	DSR	I	
<b>Multi-layer (mass laminate) printed wiring boards.</b>												
<b>O-LEADING-401</b>												
	0.2 (0.004)	0.3 (0.012)	34 (1.34)	D6	12.7 (0.5)	260	10	130	V-0	-	-	
<b>O-LEADING-407</b>												
	0.08 (0.003)	0.2 (0.008)	17 (0.67)	D5	9.2 (0.4)	260	10	170	V-0	NI	-	
<b>Multi-layer printed wiring boards.</b>												
<b>O-LEADING-408</b>												
	0.125 (0.005)	0.125 (0.005)	12 (0.47) min:1.25	D6	50.8 (2.0)	260	20	130	V-0	NI	*	
<b>Single layer printed wiring boards.</b>												
<b>O-LEADING-002</b>												
	0.76 (0.015)	1.14 (0.045)	34 (1.34)	S5	19.1 (0.8)	260	10	105	V-0	NI	-	
<b>O-LEADING-003</b>												
	0.38 (0.015)	1.14 (0.045)	34 (1.34)	S5	19.1 (0.8)	260	10	130	V-0	▲	-	
<b>O-LEADING-033</b>												
	0.15 (0.006)	0.3 (0.012)	34 (1.34)	S5	25.4 (1.0)	260	10	120	V-0	NI	-	
<b>O-LEADING-205</b>												
	0.1 (0.004)	0.3 (0.012)	34 (1.34)	D6	69.6 (2.7)	260	10	130	V-0	NI	-	
<b>O-LEADING-206</b>												
	0.15 (0.006)	0.33 (0.013)	17 (0.67)	D5	69.6 (2.7)	260	10	130	V-0	NI	-	

\* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.  
Last updated on 2017-01-27

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http://www.ul.com/onlinecertifications/UL60718RMS/ewg/zpmv2.e490354/Wiring,Printed-Component/10



Test Report

No. CANEC1805164701

Date: 03 Apr 2018

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Test Results:

Test Part Description:

Specimen No. **SGS Sample ID** **Description**  
SN1 CAN18-051647.001 Green "PCB"

Remarks:

- (1) 1 mg/kg = 1 ppm = 0.0001%
- (2) MDL = Method Detection Limit
- (3) ND = Not Detected (< MDL)
- (4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method: With reference to IEC 62321-4:2014+A1:2017, IEC62321-5:2013, IEC62321-7-2:2017, IEC 62321-6:2015 and IEC62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test Item(s)	Limit	Unit	MDL	Det
Cadmium (Cd)	100	mg/kg	2	ND
Lead (Pb)	1,000	mg/kg	2	9
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (CrVI)	1,000	mg/kg	8	ND
Sum of PBBs	1,000	mg/kg	-	ND
Monobromobiphenyl	-	mg/kg	5	ND
Dibromobiphenyl	-	mg/kg	5	ND
Tribromobiphenyl	-	mg/kg	5	ND
Tetrabromobiphenyl	-	mg/kg	5	ND
Pentabromobiphenyl	-	mg/kg	5	ND
Hexabromobiphenyl	-	mg/kg	5	ND
Heptabromobiphenyl	-	mg/kg	5	ND
Octabromobiphenyl	-	mg/kg	5	ND
Nonabromobiphenyl	-	mg/kg	5	ND
Decabromobiphenyl	-	mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg	-	ND
Monobromodiphenyl ether	-	mg/kg	5	ND
Dibromodiphenyl ether	-	mg/kg	5	ND
Tribromodiphenyl ether	-	mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether	-	mg/kg	5	ND



Member of the SGS Group (SGS SA)





3. what are the different types of PCB materials?

FR4 is the most common PCB material. Other materials include TG, Arlon, Teflon, PI, etc.

4. What are the different types of PCB design software?

Gerber 274-X, Cam350, CAD, Protel 99se, PADS, DXP, Eagle.

5. What are the different types of PCB manufacturing processes?

PCB manufacturing processes include: AOI, PTH, E/T, etc.